VS-GA100TS60SFPbF

Vishay Semiconductors

"Half-Bridge" IGBT INT-A-PAK, (Standard Speed IGBT), 100 A



www.vishay.com

INT-A-PAK

PRODUCT SUMMARY				
V _{CES}	600 V			
I _C DC	220 A			
V _{CE(on)} at 100 A, 25 °C	1.11 V			
Package	INT-A-PAK			
Circuit	Half bridge			

FEATURES

- Standard speed PT IGBT technology
- Standard speed: DC to 1 kHz, optimized for hard switching speed **RoHS**



COMPLIANT

- FRED Pt[®] antiparallel diodes with fast recovery
- Very low conduction losses
- Al₂O₃ DBC
- UL approved file E78996 📢
- Designed for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Optimized for high current inverter stages (AC TIG welding machines)
- Direct mounting to heatsink
- · Very low junction to case thermal resistance
- Low EMI

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
	Ι _C	T _C = 25 °C	220		
Continuous collector current		T _C = 130 °C	100	А	
Pulsed collector current	I _{CM}		440	A	
Peak switching current	I _{LM}		440		
Gate to emitter voltage	V _{GE}		± 20	V	
RMS isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500		
Maximum power dissipation	P _D	T _C = 25 °C	780	W	
		T _C = 100 °C	312	vv	
Operating junction temperature range	TJ		-40 to +150	°C	
Storage temperature range	T _{Stg}		-40 to +125		

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 V, I_{C} = 1 mA$	600	-	-		
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	1.11	1.28		
Collector to emitter voltage	V _{CE(on)}	I _C = 200 A	-	1.39	-	V	
		V_{GE} = 15 V, I _C = 100 A, T _J = 125 °C	-	1.08	1.22		
Gate threshold voltage	V _{GE(th)}	I _C = 0.25 mA	3	-	6		
	ICES	$V_{GE} = 0 V, V_{CE} = 600 V$	-	-	1	m۸	
Collector to emitter leakage current		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	10	mA	
Diode forward voltage drop	N/	I _C = 100 A, V _{GE} = 0 V	-	1.44	1.96	v	
Diode forward voltage drop	V _{FM}	I_{C} = 100 A, V_{GE} = 0 V, T_{J} = 125 °C	-	1.25	1.54	v	
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 250	nA	

Revision: 09-Apr-14

1

Document Number: 94544

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Semiconductors

SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	L TEST CONDITIONS		TYP.	MAX.	UNITS
Total gate charge	Qg	I _C = 100 A	-	640	700	
Gate to emitter charge	Q _{ge}	V _{CC} = 400 V	-	108	120	nC
Gate to collector charge	Q _{gc}	V _{GE} = 15 V	-	230	300	1
Rise time	tr		-	0.45	-	
Fall time	t _f	I _C = 100 A V _{CC} = 480 V	-	1.0	-	μs
Turn-on switching energy	E _{on}	V _{GE} = 15 V	-	4	6	
Turn-off switching energy	E _{off}	R _g = 15 Ω T ₁ = 25 °C	-	23	29	
Total switching energy	E _{ts}		-	27	35	- mJ
Turn-on switching energy	E _{on}	I _C = 100 A, V _{CC} = 480 V	-	6	12	
Turn-off switching energy	E _{off}	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 15 \Omega$	-	35	40	
Total switching energy	E _{ts}	T _J = 125 °C	-	41	52	
Input capacitance	C _{ies}	V _{GE} = 0 V	-	16 250	-	
Output capacitance	C _{oes}	$V_{CC} = 30 V$	-	1040	-	pF
Reverse transfer capacitance	C _{res}	f = 1.0 MHz	-	190	-	
Diode reverse recovery time	t _{rr}	I _F = 50 A	-	91	155	ns
Diode peak reverse current	I _{rr}	dI _F /dt = 200 A/μs	-	10.6	15	А
Diode recovery charge	Q _{rr}	V _{rr} = 200 V	-	500	900	nC
Diode reverse recovery time	t _{rr}	I _F = 50 A	-	180	344	ns
Diode peak reverse current	Irr	dI _F /dt = 200 A/µs	-	17	20.5	А
Diode recovery charge	Q _{rr}	V _{rr} = 200 V, T _J = 125 °C	-	1633	2315	nC

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL MIN. TY		TYP.	MAX.	UNITS	
Operating junction temperature range		TJ	-40	-	150	•	
Storage temperature range		T _{Stg}	-40	-	125	°C	
Junction to case	per switch	- R _{thJC}	-	-	0.16	°C/W	
	per diode		-	-	0.48		
Case to sink per module		R _{thCS}	-	0.1	-		
Mounting torque -	case to heatsink		-	-	4	- Nm	
	case to terminal 1, 2, 3		-	-	3	INIII	
Weight			-	185	-	g	



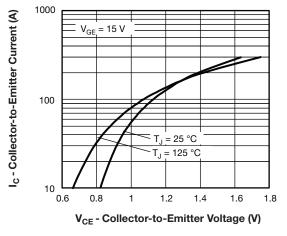


Fig. 1 - Typical Output Characteristics

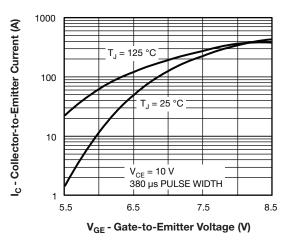


Fig. 2 - Typical Transfer Characteristics

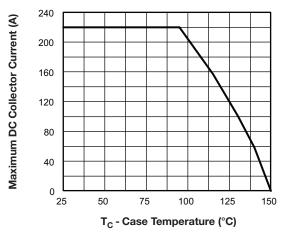


Fig. 3 - Maximum Collector Current vs. Case Temperature

VS-GA100TS60SFPbF

Vishay Semiconductors

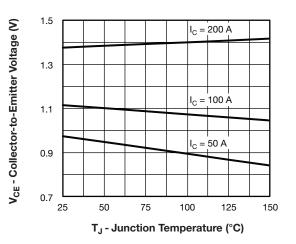


Fig. 4 - Typical Collector to Emitter Voltage vs. Junction Temperature

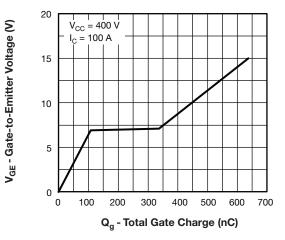


Fig. 5 - Typical Gate Charge vs. Gate to Emitter Voltage

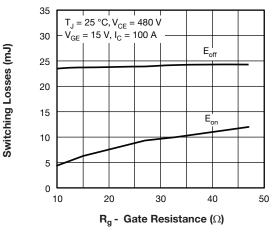


Fig. 6 - Typical Switching Losses vs. Gate Resistance

Revision: 09-Apr-14

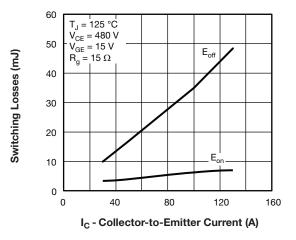
3

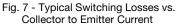
For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

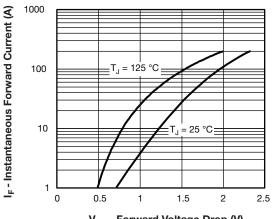


VS-GA100TS60SFPbF

Vishay Semiconductors







V_{FM} - Forward Voltage Drop (V)

Fig. 8 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

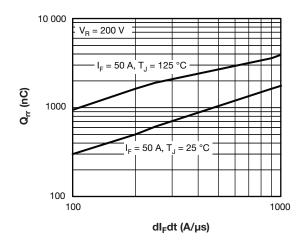


Fig. 11 - Typical Stored Charge vs. dl_F/dt

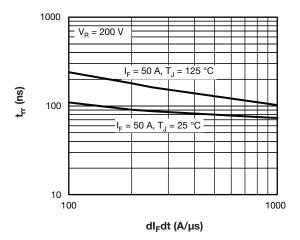


Fig. 9 - Typical Reverse Recovery Time vs. dl_F/dt

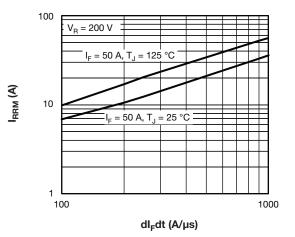


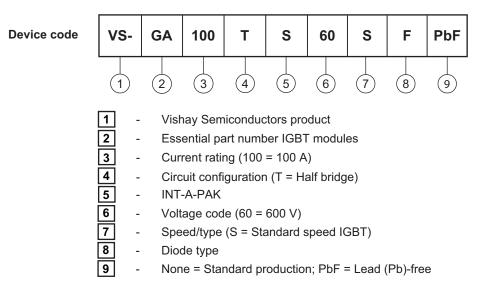
Fig. 10 - Typical Reverse Recovery Current vs. dl_F/dt

Revision: 09-Apr-14 Document Number: 94544 For technical questions within your region: DiodesAmericas@vishav.com, DiodesAsia@vishav.com, DiodesEurope@vishav.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

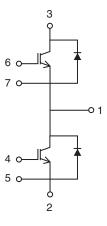


Vishay Semiconductors

ORDERING INFORMATION TABLE



CIRCUIT CONFIGURATION



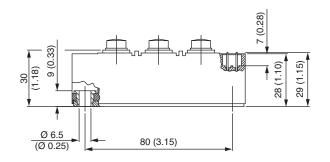
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95173			

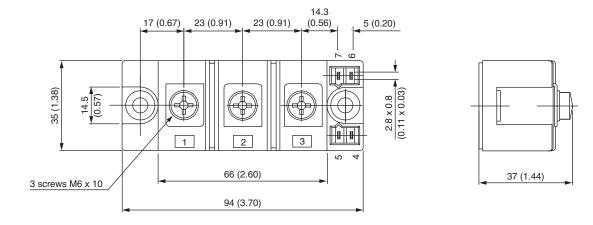




INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)







Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.